



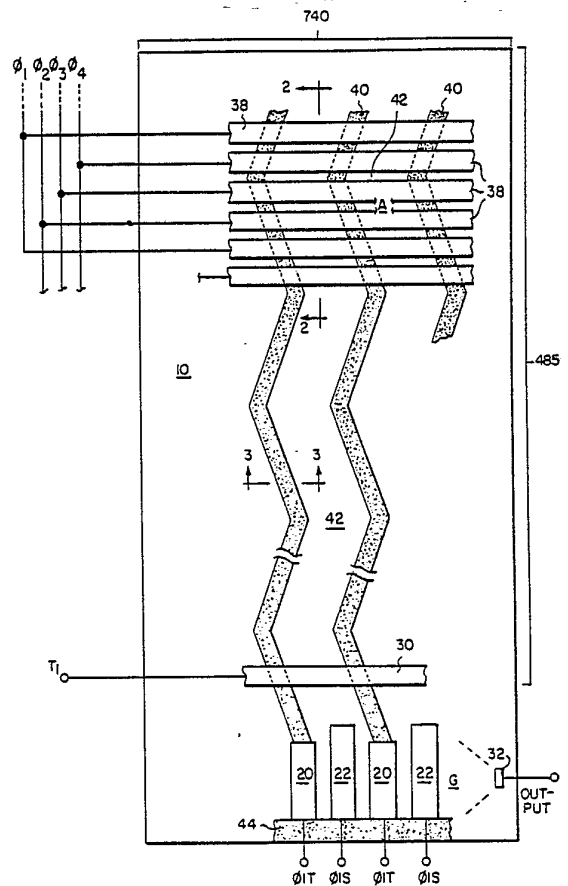
INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

<p>(51) International Patent Classification⁴ : H01L 27/14, H04N 3/15</p>	<p>A1</p>	<p>(11) International Publication Number: WO 87/ 00970 (43) International Publication Date: 12 February 1987 (12.02.87)</p>
<p>(21) International Application Number: PCT/US86/01507 (22) International Filing Date: 23 July 1986 (23.07.86) (31) Priority Application Number: 762,172 (32) Priority Date: 5 August 1985 (05.08.85) (33) Priority Country: US (71) Applicant: EASTMAN KODAK COMPANY [US/US]; 343 State Street, Rochester, NY 14650 (US). (72) Inventor: MOORE, Leslie, Gerald ; 576 Bending Bough Drive, Webster, NY 14580 (US). (74) Agent: OWENS, Raymond, L.; 343 State Street, Ro- chester, NY 14650 (US).</p>		<p>(81) Designated States: DE (European patent), FR (Euro- pean patent), GB (European patent), JP. Published <i>With international search report.</i></p>

(54) Title: FRAME TRANSFER CCD AREA IMAGE SENSOR WITH IMPROVED HORIZONTAL RESOLUTION

(57) Abstract

A frame transfer CCD area image sensor (10) having a plurality of spaced transfer channels (42) having resolution cells defined by electrodes (38). Each resolution cell samples an image scene pixel. Channel stops (40) separate the channels and are arranged to stagger adjacent resolution cells in the channels to improve horizontal resolution.



FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AT	Austria	GA	Gabon	MR	Mauritania
AU	Australia	GB	United Kingdom	MW	Malawi
BB	Barbados	HU	Hungary	NL	Netherlands
BE	Belgium	IT	Italy	NO	Norway
BG	Bulgaria	JP	Japan	RO	Romania
BR	Brazil	KP	Democratic People's Republic of Korea	SD	Sudan
CF	Central African Republic	KR	Republic of Korea	SE	Sweden
CG	Congo	LI	Liechtenstein	SN	Senegal
CH	Switzerland	LU	Luxembourg	SU	Soviet Union
CM	Cameroon	LK	Sri Lanka	TD	Chad
DE	Germany, Federal Republic of	MC	Monaco	TG	Togo
DK	Denmark	MG	Madagascar	US	United States of America
FI	Finland	ML	Mali		
FR	France				

-1-

FRAME TRANSFER CCD AREA IMAGE SENSOR
WITH IMPROVED HORIZONTAL RESOLUTION

Technical Field

This invention relates to frame transfer CCD area image sensors with improved resolution.

Background Art

One well known organization of CCD area image sensors is the frame or field transfer organization. In this arrangement, charge transfer channels run in vertical directions. Separating each transfer channel is a channel stop which confines charge collected to the transfer channels and prevents charge leakage into adjacent channels. Channel stops are provided by thick field oxides and also by diffusion or implants in the substrate. Each transfer channel has a plurality of resolution cells. Each resolution cell is defined by a plurality of closely spaced, independent electrodes. An independent electrode is one which is separately addressable. So for example a three-phase CCD has three independent electrodes per cell, and a four-phase CCD has four independent electrodes per cell. Each electrode is formed on an insulator which overlays a substrate. The electrodes can be made from transparent polysilicon or metal conductors. As is well known in applications where an image is sampled and displayed on a T.V., there are two fields for each frame. During the first field a potential is applied to at least one electrode of each resolution cell and a depletion region or well is formed under it. Photocharge collected in the well is a function of scene brightness level. The photocharge is then read out and converted to voltage signals which are used to produce an image. During the next field, a depletion region is formed under another electrode of each resolution cell thereby vertically shifting the integration site for each

-2-

resolution cell for the second field. This "virtual" interlacing effectively increases vertical resolution without substantially modifying the vertical modulation transfer function (MTF). This approach is widely used but suffers from the shortcoming that horizontal resolution is not improved. One way to improve horizontal resolution is to increase the number of resolution cells per unit length in the horizontal dimension. This approach increases complexity and reduces the yield of area image sensors thereby increasing their cost. Also, between fields of a frame, the area image sensor can be moved horizontally relative to an object scene to increase horizontal resolution.

Disclosure of the Invention

The object of this invention is to provide a frame transfer CCD area image sensor in which horizontal resolution is improved without increasing the number of sensor resolution cells or having to move the sensor relative to an image.

This object is achieved by a frame transfer CCD area image sensor which includes a plurality of spaced transfer channels having resolution cells. Each resolution cell samples a scene image and accumulates charge representing the brightness level of an image pixel. The channel resolution cells are arranged to define an array of rows and columns of resolution cells. The sensor further includes channel stops which separate the transfer channels and are arranged to stagger adjacent resolution cells of each channel to improve resolution.

In one preferred embodiment, each resolution cell includes a plurality of electrodes. A potential energy well can be formed under a first electrode of a resolution cell during a first field of a frame and formed under a second electrode of such resolution cell during a second field of the frame. Horizontal

-3-

staggering of the center of charge of adjacent cells within each field occurs from row-to-row and the vertical shift of the center of charge (virtual interlace) by each cell occurs from field-to-field within each frame.

An advantage of this invention is that it reduces both vertical and horizontal aliasing effects.

Another advantage of this invention is that it is suitable for single CCD sensors using color filter arrays. An integral color filter can, for example, be disposed over each channel.

Description of the Drawings

Fig. 1 is a schematic overall view of a frame transfer CCD area image sensor in accordance with the present invention showing in an exploded format resolution cells of several staggered transfer channels;

Fig. 2 is a cross-sectional view taken along the lines 2-2 of Fig. 1 showing a resolution cell in a transfer channel of the sensor;

Fig. 3 is a cross-sectional view taken along the lines 3-3 of Fig. 1 showing a channel stop between adjacent transfer channels;

Fig. 4a and 4b are schematic diagrams showing the collection of charge in different potential wells by the resolution cells of the Fig. 1 sensor in first and second fields of operation, respectively; and

Fig. 5 is a schematic diagram showing the collection of charge for a frame transfer CCD image sensor having a different staggered sensor resolution cell pattern than in Fig. 1.

Modes of Carrying out the Invention

The overall configuration of a CCD area image sensor 10 which embodies the present invention is shown in Fig. 1. For clarity of illustration, this view is not to scale. The image sensor 10

-4-

comprises a frame transfer four-phase (voltage lines ϕ_1 - ϕ_4) and a surface channel CCD area image sensor. The image is sensed by resolution cells in transfer channel 42. As will be described, each resolution cell is defined by a plurality of transparent, independent electrodes 38. By way of illustration only, the resolution cells are arranged in a staggered two-dimensional array (A) having 740 staggered columns and 485 rows of resolution cells. Each transparent electrode is connected to one line or phase of a four-phase clock signal. After exposure the four clock signals are sequentially applied in the well known manner to the image sensing array A to move the imagewise charge pattern formed in the sensor resolution cells one row at a time to an output register G. Between adjacent transfer channels there are provided channel stops 40. These channel stops 40 are staggered so as to improve horizontal resolution in a manner which will be described later.

A 14 MHz clock drives the clock signals for reading out the rows of the image sensor at the standard television line rate. The output register G is a conventional two-phase CCD shift register positioned between a transfer gate 30 and a horizontal channel stop 44. Each cell of the output register G includes a transfer electrode 20 aligned with a vertical channel stop 40 and a storage electrode 22 which is aligned with a transfer channel 42. These electrodes are actuated by signals on lines ϕ_{1T} and ϕ_{1S} respectively.

The operation of the gate 30 and the output register G is well known in the art and so will only be briefly described. The transfer gate 30 which is actuated by a first transfer signal T_1 and transfers a row of photocharges to the output register G. As noted above, each cell in the output

-5-

register G has a storage electrode 22 associated with a transfer column of the array A. When a row of photocharges is to read out of image sensing array A, the transfer gate 30 is opened and photocharges are delivered to storage wells which have been formed under the electrodes 22.

After a row of photocharge (electrons) has been transferred to the output register G, the transfer gate 30 is closed. By being closed is meant that a potential barrier is formed under this transfer electrode. At this time the output register is operated in a two-phase manner clocking the photocharges out through an output diode 32 which converts the photocharges into a voltage in the well-known manner.

Turning now to Fig. 2, the CCD sensor is shown to be constructed on a doped semiconductor substrate 34 (e.g. p-type silicon). A silicon dioxide, SiO_2 , layer 36 is grown on the substrate 34. Silicon dioxide has the fundamental property of preventing the diffusion of impurities through it. Polysilicon conductive electrodes 38 are then deposited on the silicon dioxide layer 36. The conductive electrodes could also be made of a metal such as aluminum. The silicon dioxide layer 36 and the electrodes 38 are transparent and permit photons of light to pass through them into the bulk of substrate 34. A thin protective layer 37 of silicon dioxide overcoats the electrodes 38.

Channel stops 40, shown in Fig. 3, are defined by a more heavily doped (e.g. p+) region covered by a thickened oxide layer 44. The transfer channels 42 are as noted above separated by the channel stops 40 and overlaid with the four-phase transfer electrodes 38. The thickened field oxide and doped region in the channel stop area is selected such that the bulk p-type silicon directly below it

-6-

never becomes depleted notwithstanding the voltage applied to its electrode 38.

When a potential is applied to an electrode 38, a depletion region is formed under that electrode. As shown in Fig. 2, a resolution cell or pixel includes four electrodes. If, for example, the same positive potential is applied by voltage lines ϕ_1 and ϕ_2 and no potential is applied to voltage lines ϕ_3 and ϕ_4 , a depletion region is formed in the substrate 34 under those electrodes having applied potential. When the positive potential is applied, it repels holes into the substrate. Lattice electrons are exposed and the depletion region is thereby formed. The potential profile of the depletion region is referred to as an energy or potential well and is shown in Fig. 2 as a dotted line 39.

Since the electrodes are transparent, during exposure, scene light passes through them and photons of light are absorbed in the substrate. Free electrons are produced by a photoelectric conversion process and are collected in the potential well as schematically shown in Fig. 2. These electrons (photocharge) are free to move about but can not penetrate the walls of the potential well. The potential profile on the different electrodes can now be changed by varying the voltages on lines ϕ_1 - ϕ_4 so as to shift the charge down into the horizontal readout register G. As shown in Fig. 1, the photocharge shifted into the register G is now shifted to the diode 32 which converts the photocharge into a voltage. The charge transfer channels 40 and the shift register G are standard charge transfer arrangements wherein by properly applying periodic voltages to their electrodes a moving array of potential wells can be formed in which charge is shifted from one position to

-7-

another. The operation of these types of charge transfer devices is well known in the art and described fully in the text book CHARGE TRANSFER DEVICES by Sequin et al. Pages 23-25 describe the operation of a conventional four-phase CCD electrode structure and pp. 25-30 describe the operation of conventional two-phase CCD electrode structures.

As shown in Fig. 1, the channel stops define a staggered or alternating pattern of resolution cells in each column in the form of a zig-zag. The term stagger is in reference to the situation where the center of charge collection of adjacent resolution cells in a channel are offset. The horizontal structure of a resolution cell is defined between channel stops while the electrodes define the vertical structure. Virtual interlacing is implemented in the conventional manner by changing the center of charge of each resolution cell.

Reference may now be made to Figs. 4a and 4b which illustrate the operation of a two field per frame device in its first and second fields, respectively. As shown in Fig. 4a, a positive potential is applied to the lines ϕ_1 and ϕ_2 , and a potential well for each resolution cell is formed under these electrodes and charge collects in them. The center of charge for each resolution cell is shown at position F_1 . In the second field of operation shown in Fig. 4b, a positive potential is applied to the lines ϕ_3 and ϕ_4 and charge is collected under these electrodes. In this case, the center of charge is shown as F_2 . Thus, during the first field, charge will be collected in the potential well under all the electrodes connected to lines ϕ_1 and ϕ_2 and during the second field, charge will be collected under all the electrodes connected to lines ϕ_3 and ϕ_4 . In each field, the center of charges of adjacent resolution cells in

-8-

each channel 42 are offset or staggered horizontally. When the center of charges of each resolution cell are connected, the result is a non-linear pattern. In each row of resolution cells, if the center of charges are connected, the result is a linear pattern.

Due to virtual interlace, in the first field each resolution cell samples a different image pixel than it samples in the second field. Image pixels sampled by adjacent resolution cells in a channel are offset horizontally from row-to-row within a field and vertically from field-to-field within a frame. Moreover, where there are two fields per frame, the center of collected charge of each resolution cell from field-to-field is shifted not only vertically but also horizontally. Thus, there is an improvement in both vertical and horizontal resolution.

Although the image sensor 10 has been described as a surface channel sensor, it will be understood that the invention is also applicable to a buried channel sensor. In a buried channel CCD sensor, the electrodes are disposed on an insulator such as SiO_2 . The insulator overlies the substrate. The bulk substrate is doped and can be of a given polarity for example p-type. Near the insulator the substrate is of a polarity (n-type) opposite to that of the bulk substrate and of such a concentration that when a predetermined potential is applied to the electrode, a channel or potential well is formed within the substrate spaced from the insulator. Charge is collected in this channel or well which is a function of scene brightness. More specifically, carriers are produced by a photoelectric conversion process and collected in the channel.

-9-

Turning now to Fig. 5, where charge collection for another frame transfer CCD area image sensor is shown. The image area CCD represented has a different staggered channel stop structure. This image area sensor has an array of rows and staggered columns of rectangular shaped resolution cells. This arrangement is particularly suitable for pattern recognition devices which have a single field per frame. Each resolution cell in each channel 42 is defined horizontally between channel stops 40 and vertically by four electrodes 38. Each electrode 38 is connected to a particular one or four voltage phase lines ϕ . If a positive potential is applied to line ϕ_1 and ϕ_2 , a potential well for each resolution cell is formed under these electrodes and charge collects in them. In such a situation, the center of charge is shown as F_1 . For adjacent resolution cells in a channel 42, the position of the center of charges are offset or staggered horizontally. The construction of adjacent channel stops 40 stagger adjacent resolution cells. Each resolution cell has a rectangular configuration. If a line were to connect the center of charge in each column, it would be non-linear. If a line were to connect the center of charge in each row, it would be linear.

Industrial Applicability

A frame transfer CCD area image sensor is useful for forming an image wise charge pattern representing an image.

An advantage of this invention is that it improves horizontal resolution.

An advantage of this invention is that it reduces both vertical and horizontal aliasing effects.

Another advantage of this invention is that it is suitable for single CCD sensors using color filter arrays. An integral color filter can, for example, be disposed over each channel.

-10-

Claims:

1. A frame transfer CCD area image sensor having a plurality of transfer channels separated by channel stops, each channel having a plurality of resolution cells each of which samples light from an image pixel to collect electrons, characterized by the channel stops being arranged to stagger adjacent resolution cells of a channel to improve resolution.
2. A frame transfer CCD area image sensor including a plurality of spaced transfer channels having resolution cells each of which samples light from an image scene and accumulates photocharge representing the brightness level of an image pixel, such resolution cells being arranged to define an array of rows and columns of resolution cells; characterized by channel stops which separate the transfer channels and are arranged to stagger adjacent resolution cells in a channel; and output register means for sequentially receiving photocharges from each row of resolution cells during a readout operation.
3. A frame transfer CCD area image sensor for sensing different fields of an image, including a plurality of spaced transfer channels having a plurality of resolution cells arranged so as to define an array of rows and columns of resolution cells each of which accumulates charge representing the brightness level of light from a sampled image scene pixel, each channel resolution cell includes a substrate, a transparent nonconductive layer covering the substrate and a predetermined number of closely spaced, independent transparent electrodes to which potential can be applied; characterized by channel stops which separate the transfer channels and are arranged to stagger adjacent resolution cells in a channel; and means for applying potential to selective ones of the electrodes of each resolution

-11-

cell during first and second fields of a frame so that a potential energy well is formed under a first electrode of each resolution cell to collect charge representing the brightness level of a scene image pixel during the first field and a potential barrier is formed under a second electrode of each resolution cell and during the second field a potential well is formed under the second electrode to collect charge representing the brightness level of another image scene pixel and a potential barrier is formed under the first electrode, whereby horizontal staggering of the center of charge of adjacent resolution cells in a channel occurs from row-to-row within each field and the vertical shifting of the center of charge sensed by each resolution cell occurs from field-to-field within each frame.

4. A frame transfer CCD area image sensor characterized by:

a) a plurality of spaced transfer channels having resolution cells each of which samples a scene image and accumulates photocharge representing the brightness level of an image pixel, such resolution cells being arranged to define an array of rows and columns of resolution cells; and

b) channel stops which separate the transfer channels and are arranged to stagger adjacent resolution cells in a channel so that the center of charge collected under adjacent resolution cells in each channel are non-linear and the center of charges of each row of the array are linear.

5. A frame transfer CCD area image sensor for sensing different fields of an image, characterized by:

a. a plurality of spaced transfer channels having a plurality of resolution cells arranged so as to define an array of resolution cells each of which accumulates photocharge representing the brightness

-12-

level of a sampled image scene pixel, each channel resolution cell includes a substrate, a transparent nonconductive layer covering the substrate and a plurality of closely spaced, independent transparent electrodes to which potential can be applied;

b. channel stops which separate the transfer channels and are arranged to stagger adjacent resolution cells in a channel;

c. means for applying potential to selective ones of the electrodes of each resolution cell during first and second fields of a frame so that a potential energy well is formed under a first electrode of each resolution cell to collect charge representing the brightness level of a scene image pixel during the first field and a potential barrier is formed under a second electrode of each resolution cell and during the second field a potential well is formed under the second electrode to collect charge representing the brightness level of another image scene pixel and a potential barrier is formed under the first electrode whereby horizontal staggering of the center of charge of adjacent resolution cells in a channel occurs from row-to-row within each field and the vertical shifting of the center of charge sensed by each resolution cell occurs from field-to-field within each frame; and

d. output register means for sequentially receiving charge from each row of resolution cells during a readout operation.

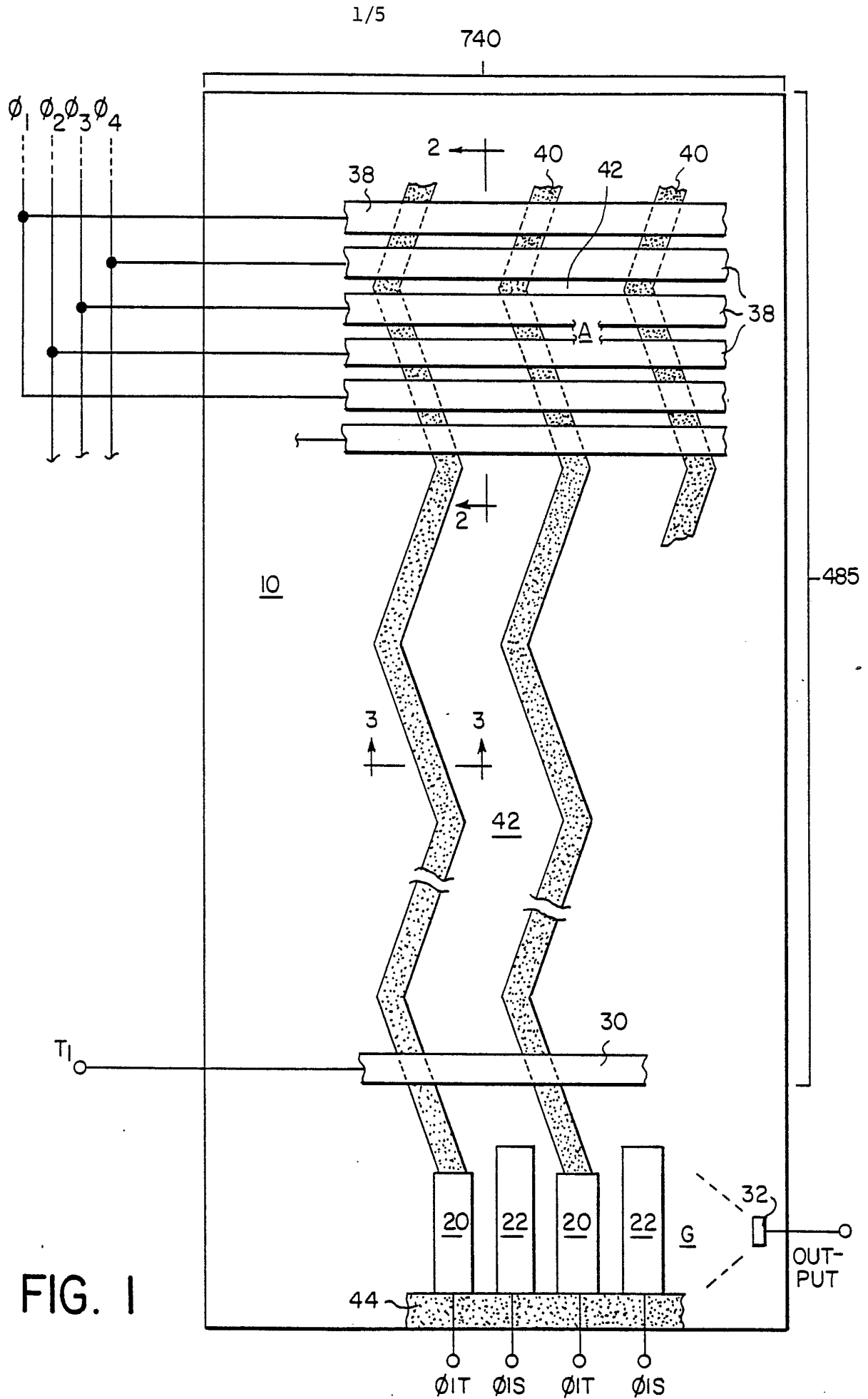


FIG. 1

2/5

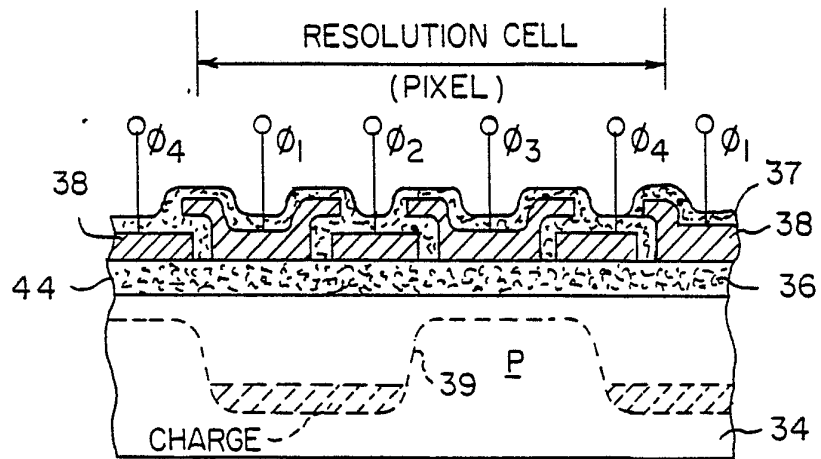


FIG. 2

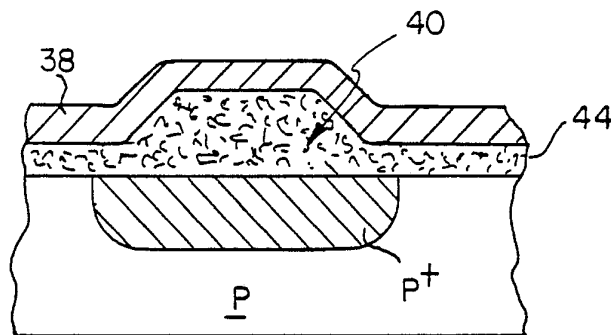


FIG. 3

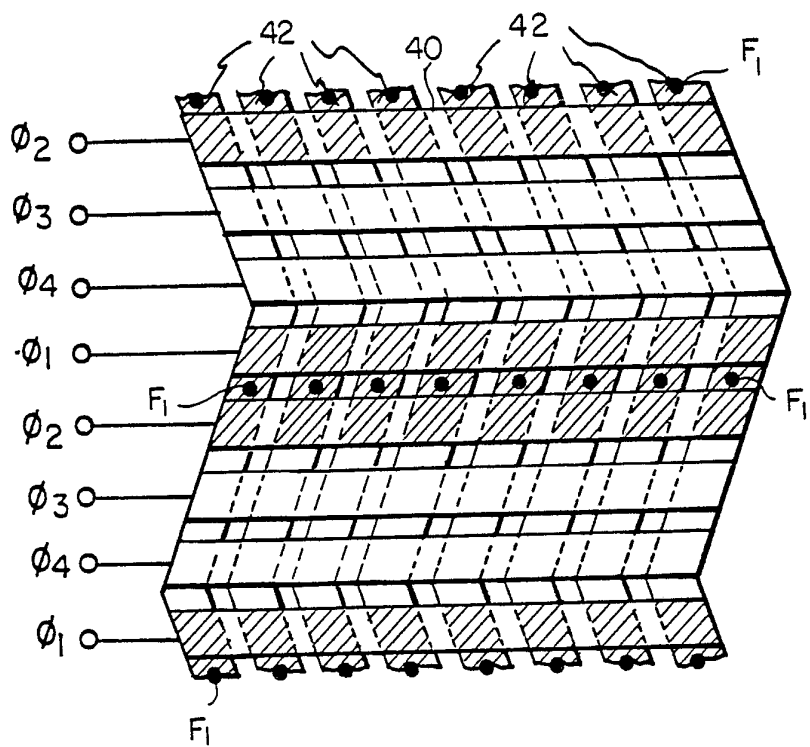


FIG. 4a

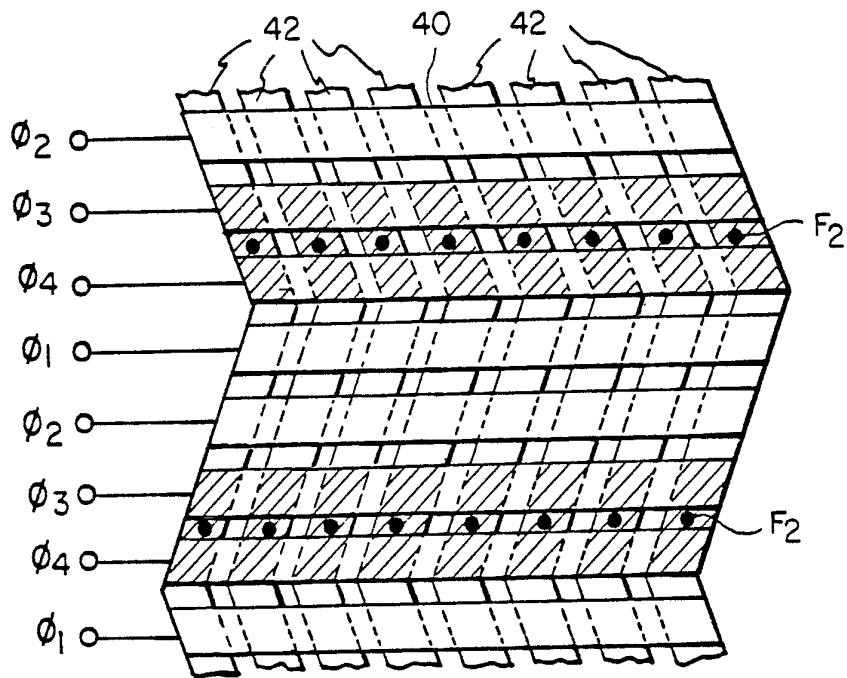


FIG. 4b

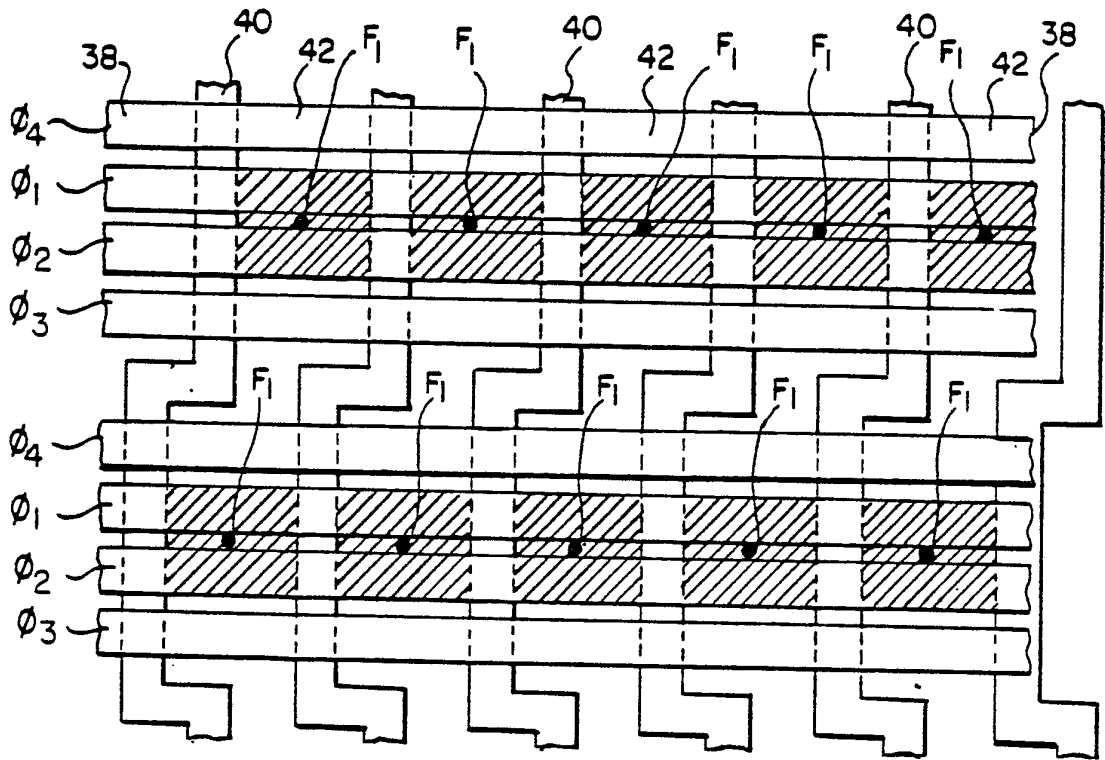
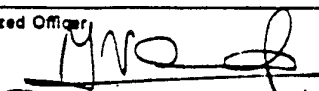


FIG. 5

INTERNATIONAL SEARCH REPORT

International Application No PCT/US 86/01507

I. CLASSIFICATION OF SUBJECT MATTER (if several classification symbols apply, indicate all) ⁶		
According to International Patent Classification (IPC) or to both National Classification and IPC		
IPC ⁴ : H 01 L 27/14; H 04 N 3/15		
II. FIELDS SEARCHED		
Minimum Documentation Searched ⁷		
Classification System	Classification Symbols	
IPC ⁴	H 01 L; H 04 N	
Documentation Searched other than Minimum Documentation to the Extent that such Documents are Included in the Fields Searched ⁸		
III. DOCUMENTS CONSIDERED TO BE RELEVANT ⁹		
Category ⁹	Citation of Document, ¹¹ with Indication, where appropriate, of the relevant passages ¹²	Relevant to Claim No. ¹³
A	IBM Technical Disclosure Bulletin, vol. 19, no. 5, October 1976 (New York, US) E.M. Winter: "Light-detector matrix arrangement", pages 1864-1865, see figures 2,3; page 1865, last paragraph	1
A	--	
A	US, A, 4204230 (R.A. SPRAGUE) 20 May 1980 see figure 11; column 6, lines 47-53	1
A	--	
A	FR, A, 2275091 (SONY CORPORATION) 9 January 1976 see figures 1,2; claims 1,2; page 5, line 36 - page 6, line 9	1-5
A	--	
A	US, A, 4291239 (P.K. WEIMER) 22 September 1981 see figures 1,2; column 2, line 43 - column 5, line 53	1-5

<p>¹⁰ Special categories of cited documents:</p> <p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier document but published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p> <p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step</p> <p>"Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.</p> <p>"&" document member of the same patent family</p>		
IV. CERTIFICATION		
Date of the Actual Completion of the International Search	Date of Mailing of this International Search Report	
15th September 1986	23 OCT 1986	
International Searching Authority	Signature of Authorized Officer	
EUROPEAN PATENT OFFICE	J. VAN MOL 	

ANNEX TO THE INTERNATIONAL SEARCH REPORT ON

INTERNATIONAL APPLICATION NO. PCT/US 86/01507 (SA 14128)

This Annex lists the patent family members relating to the patent documents cited in the above-mentioned international search report. The members are as contained in the European Patent Office EDP file on 02/10/86

The European Patent Office is in no way liable for these particulars which are merely given for the purpose of information.

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
US-A- 4204230	20/05/80	EP-A, B 0010926	14/05/80
		JP-A- 55060383	07/05/80
		CA-A- 1136275	23/11/82
FR-A- 2275091	09/01/76	JP-A- 50127821	08/10/75
		NL-A- 7503874	01/10/75
		DE-A, C 2514156	09/10/75
		AU-A- 7954575	30/09/76
		US-A- 4071853	31/01/78
		GB-A- 1501017	15/02/78
		JP-A- 51012730	31/01/76
		CA-A- 1065050	23/10/79
AT-B- 362430	25/05/81		
US-A- 4291239	22/09/81	None	

For more details about this annex :
see Official Journal of the European Patent Office, No. 12/82